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Docket No.	

## **COMBINED DECLARATION/POWER OF ATTORNEY FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

2002-333687   JAPAN   18/11/2002   X Yes   (Number)   (Country)   (Day/Month/Year Filed)   Yes   (Number)   (Country)   (Day/Month/Year Filed)				
Check one   X   is attached hereto.	n original, first and jo s claimed and for whic	int inventor (if plu h a patent is sough	tral names are listed below at on the invention entitled	) of the subject matter which
(check one)  X is attached hereto.  Was filed on	SEMICONDUCTO  OFSIGNING THE SA	<u>n integrate</u> Me		
was filed onas Application Serial Noas Application Serial Noas Application Serial No	DESIGNING THE SA	IVIL		, the specification of which
Application Serial No	check one)	X is attached h	nereto.	
Application Serial No		was filedon		25
I acknowledge the duty to disclose information which is material to the examinathis application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).  I hereby claim foreign priority benefits under Title 35, United States Code, § any foreign application(s) for patent or inventor's certificate listed below and havidentified below any foreign application for patent or inventor's certificate having a filiphefore that of the application on which priority is claimed:  Prior Foreign Application(s)  Priority Cl  2002-333687  JAPAN  (Number)  (Country)  JAPAN  (Day/Month/Year Filed)  Yes  (Number)  Yes	_	_		as
2002-333687         JAPAN         18/11/2002         X         Yes           (Number)         (Country)         (Day/Month/Year Filed)         Yes           (Number)         (Country)         (Day/Month/Year Filed)         Yes	I hereby claim I hereby claim ny foreign application dentified below any foreign	foreign priority benefits for patent or or patent or or patent or	7, Code of Federal Regulators, Code of Federal Regulators of the second	ions, § 1.56(a).  sited States Code, § 119 of sted below and have also
(Number) (Country) (Day/Month/Year Filed)  Yes  (Number) (Country) (Day/Month/Year Filed)  Yes	rior Foreign Application	on(s)		Priority Claimed
(Number) (Country) (Day/Month/Year Filed)  Yes  (Number) (Country) (Day/Month/Year Filed)  Yes	2002-333687	JAPAN	18/11/2002	Y Ves No
(Number) (Country) (Day/Month/Year Filed) YesYes				
	(Number)	(Country)		Yes No
	(Number)	(Country)	(Day/Month/Year Filed)	Yes No

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Appln. Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)		
(Appln. Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)		

I hereby appoint as my attorneys, with full power of substitution and revocation to prosecute the patent application identified above and to transact all business in the U.S. Patent and Trademark Office connected therewith: Raphael V. Lupo (Reg. No. 28,363); Jack Q. Lever, Jr. (Reg. No. 28,149); Kenneth L. Cage (Reg. No. 26,151); Stanislaus Aksman (Reg. No. 28,562); Paul Devinsky (Reg. No. 28,553); Edward E. Kubasiewicz (Reg. No. 30,020), Michael E. Fogarty (Reg. No. 36,139); Brian E. Ferguson (Reg. No. 36,801); Robert W. Zelnick (Reg. No. 36,976); and Wilhlem F. Gadiano (Reg. No. 37,136).

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The undersigned hereby authorizes the U.S. attorneys named herein to accept and follow instructions from Maeda Patent Office as to any action to be taken in the Patent and Trademark Office regarding this application without direct communication between the U.S. attorney and the undersigned. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by the undersigned.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United Sates Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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Full name of second inventor		Akimitsu SHIN	<del>-</del>			
Inventor's signature	Akimitsu	SHIMAMURA	Date	Seo.	18 <sup>-</sup> , 2003	
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